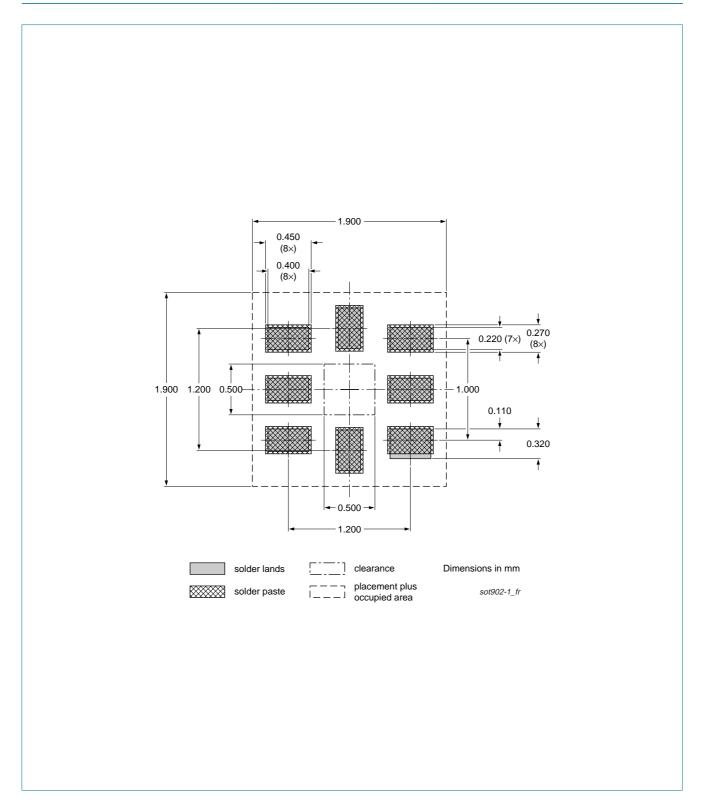
Footprint for reflow soldering of XQFN8 package

SOT902-1



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